

SECURE DIGITAL MEMORY CARD

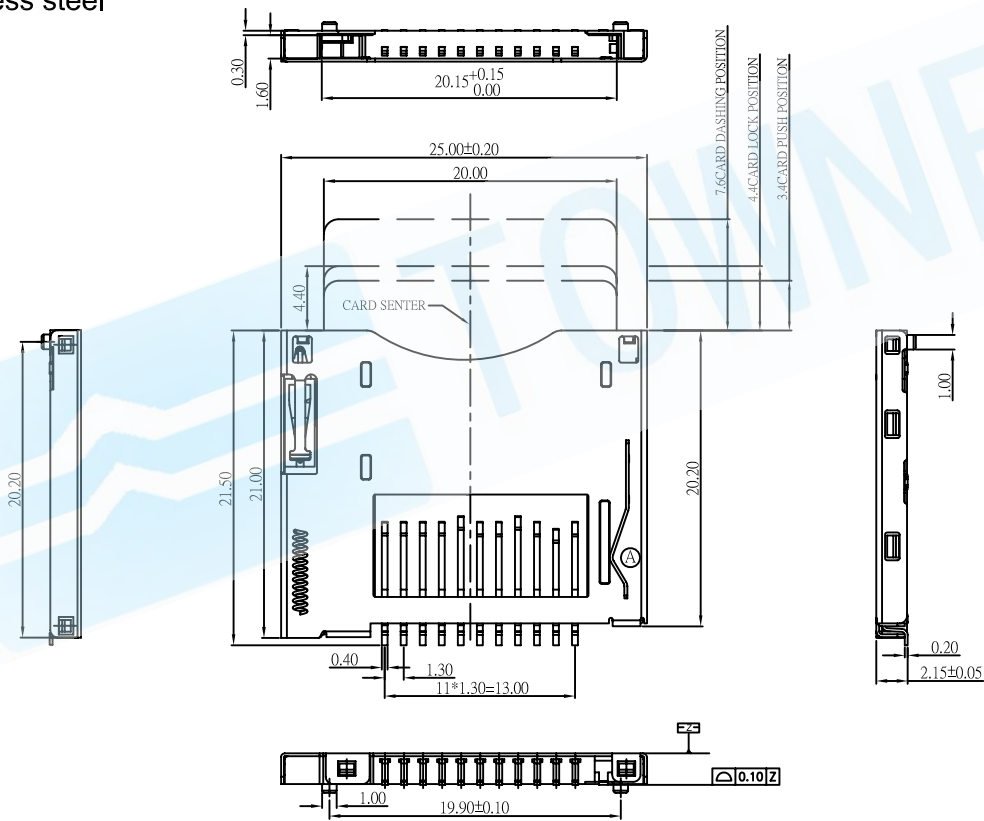
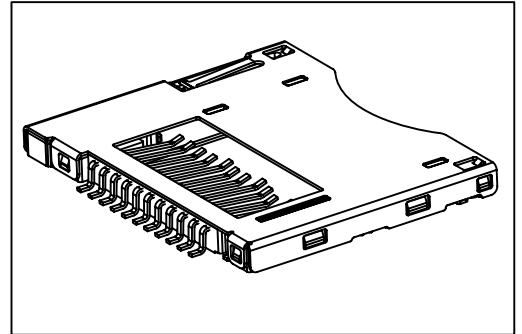
MINI SD CARD PUSH (REVERSE TYPE)

Specifications:

Current Rating:0.5 Amp
 Voltage Rating:100V AC/DC
 Contact resistance:100m Ohm Max
 Insulator resistance: 1,000M ohm min.
 Withstanding Voltage:500V AC/Minute
 Operating Temperature Range:-20°~+85° C

Material And Finish

Insulator:High Temperature Plastic(UL 94V-0)
 Contact:Copper Alloy
 Contact Plated:Selective Gold plated(standard)
 Shell:Stainless steel



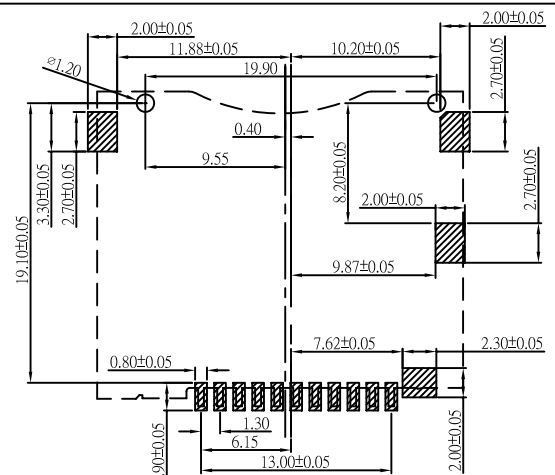
How To Order

TMSD-11XX-001

Code
 Contact Plated
 No. Of Contact

| POSITION OF CARD | DETECT TERMINAL |
|------------------|-----------------|
| DASHING | CLOSE |
| LOCK | OPEN |
| FULL STROKE | OPEN |

| Full Gold Type | Selective Plated Type Gold Plated on Contact Area Tin Plated on Solder Area | Full Tin Type |
|---|--|----------------------------------|
| GF : Gold Flash G1 : Gold 3u" G2 : Gold 5u" G3 : Gold 10u" G4 : Gold 15u" G5 : Gold 20u" G6 : Gold 30u" | HF : Gold Flash, Tin 100u" H1 : Gold 3u", Tin 100u" H2 : Gold 5u", Tin 100u" H3 : Gold 10u", Tin 100u" H4 : Gold 15u", Tin 100u" H5 : Gold 20u", Tin 100u" H6 : Gold 30u", Tin 100u" | T1 : Tin 100u" T2 : Tin 200u" |



Recommended PCB Layout
 Tolerance: 0.05mm [TOP View]